



DFLF1800

1.0A SURFACE MOUNT FAST RECOVERY RECTIFIER PowerDI123

Product Summary (@T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)
800	1	1.35	10

Description

Packaged in the compact thermally efficient PowerDI[®]123 package, the DFLF1800 provides fast recovery time for high efficiency.

Applications

It is ideally suited to use in:

- AC-DC Adaptors/Chargers
- DC-DC Converters
- Power Supply

Features and Benefits

- Ideally Suited for Automated Assembly
- Fast Recovery Time for High Efficiency
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- Patented Interlocking Clip Design for High-Surge Capacity, US Patent #7,095,113

Mechanical Data

- Case: PowerDI123
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.01 grams (Approximate)

PowerDI[®]123



Top View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DFLF1800-7	Commercial	PowerDI123	3,000/Tape & Reel
DFLF1800-13	Commercial	PowerDI123	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



S18 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Ye	ear	2012		2013	2014		2015	2016	6	2017	2018	3	2019
Co	de	Z		Α	В		С	D		Е	F		G
Moi	nth	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Co	de	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	800	٧
Average Rectified Output Current (see Figure 4)	lo	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	25	А

Thermal Characteristics

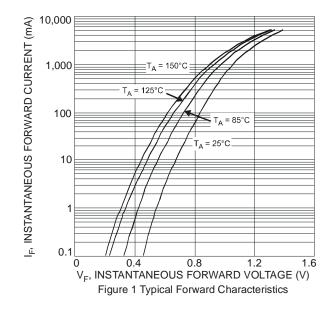
Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ heta JA}$	134	_	°C/W
Thermal Resistance, Junction to Case (Note 5)	R _{eJC}	24	_	
Thermal Resistance, Junction to Soldering Point (Note 6)	Reus	_	6	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	_	-65 to +150	°C

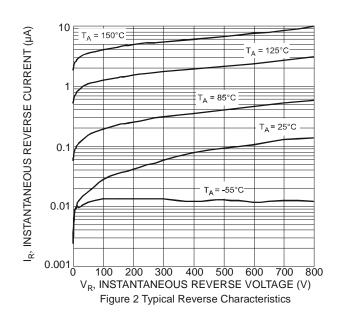
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	800	_	_	V	$I_R = 10\mu A$
Forward Voltage Drop	V _F	_	_	1.35	V	I _F = 1.0A, T _J = +25°C
Reverse Leakage Current (Note 7)	I _R	_	_	10	μA	$V_R = 800V, T_J = +25$ °C
Neverse Leakage Current (Note 1)		_	_	20	μΛ	V _R = 800V, T _J = +125°C
Total Capacitance	Ст	_	7	_	pF	$V_R = 4.0V_{DC}$, $f = 1MHz$
Reverse Recovery Time	t _{rr}	_	_	500	nS	$I_F = 0.5A$, $I_R = 1A$, $I_{RR} = 0.25A$

Notes:

- 5. Device mounted on 1" x 1", FR-4 PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document at http://www.diodes.com/package-outlines.html T_A = +25°C.
- 6. Theoretical Reus calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
- 7. Short duration test pulse used to minimize self-heating effect.







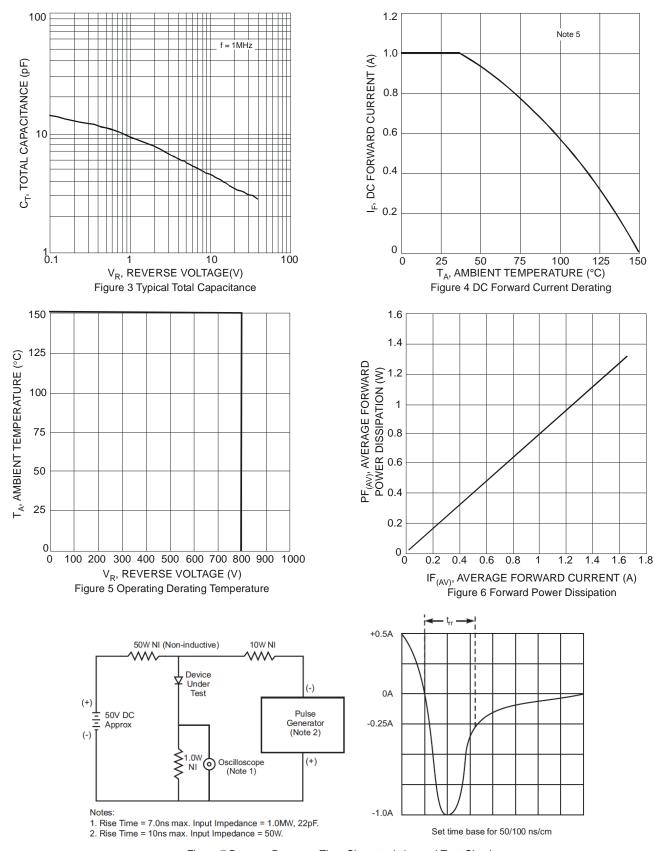


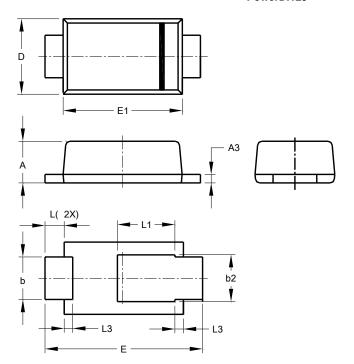
Figure 7 Reverse Recovery Time Characteristics and Test Circuit



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123

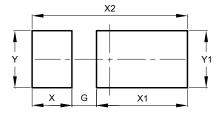


PowerDI123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
А3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value (in mm)				
G	0.65				
Х	1.05				
X1	2.40				
X2	4.10				
Y	1.50				
Y1	1.50				



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